SUD23N06-31L

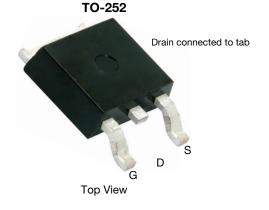


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RoHS

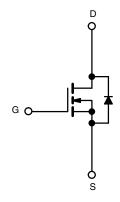
N-Channel 60 V (D-S), 175 °C MOSFET, Logic Level

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _d (A) ^a	
60	0.031 at V _{GS} = 10 V	23	
	0.045 at V_{GS} = 4.5 V	19.5	



FEATURES

- TrenchFET[®] power MOSFET
- 175 °C junction temperature
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

Ordering Information: SUD23N06-31L-E3 (lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T ₁ = 175 °C) ^b	T _C = 25 °C		23		
Continuous Drain Current $(1) = 175^{\circ}$ C) ²	T _C = 100 °C	I _D	16.5		
Pulsed Drain Current	I _{DM}	50	А		
Continuous Source Current (Diode Conduction)	I _S	23			
Avalanche Current	I _{AS}	20			
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	20	mJ	
Maximum Rower Dissinction	T _C = 25 °C	р	37.5	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^a		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	18	22	°C/W
Maximum Junction-to-Ambient ~	Steady State		40	50	
Maximum Junction-to-Case		R _{thJC}	3.2	4	

Note

a. Surface mounted on 1" x 1" FR4 board.

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SUD23N06-31L Vishay Siliconix



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP. ^a	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = 250 μ A	60	-	-	v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2	3	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	50	
		V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 175 °C	-	-	250	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	50	-	-	А
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.025	0.031	
Drain-Source On-State Resistance b	Б	V_{GS} = 10 V, I_D = 15 A, T_J = 125 °C	-	-	0.055	Ω
Drain-Source On-State Resistance	R _{DS(on)}	V_{GS} = 10 V, I_{D} = 15 A, T_{J} = 175 $^{\circ}\text{C}$	-	-	0.069	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.037	0.045	
Forward Transconductance b	g fs	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	20	-	S
Dynamic ^a						
Input Capacitance	C _{iss}		-	670	-	pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	-	140	-	
Reverse Transfer Capacitance	C _{rss}		-	60	-	
Total Gate Charge ^c	Qg		-	11	17	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_{D} = 23 A	-	3	-	nC
Gate-Drain Charge ^c	Q _{gd}		-	3	-	
Turn-On Delay Time ^c	t _{d(on)}		-	8	15	
Rise Time ^c	tr	V_{DD} = 30 V, R_L = 1.3 Ω	-	15	25	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 23$ A, V_{GEN} = 10 V, R_g = 2.5 Ω	-	30	45	ns
Fall Time ^c	t _f		-	25	40	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)				
Pulsed Current	I _{SM}		-	-	50	А
Diode Forward Voltage	V _{SD}	$I_F = 15 \text{ A}, V_{GS} = 0 \text{ V}$	-	1	1.5	V
Reverse Recovery Time	t _{rr}	I _F = 15 A, dl/dt = 100 A/μs	-	30	60	ns

Notes

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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55 °C

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 $V_{GS} = 10 V$

4

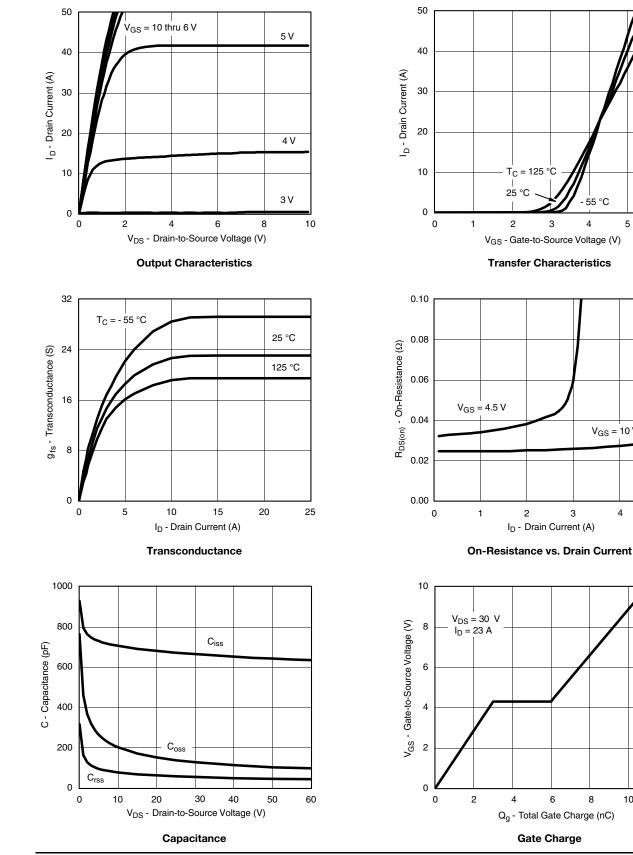
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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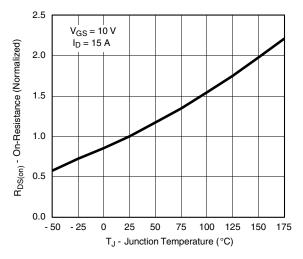
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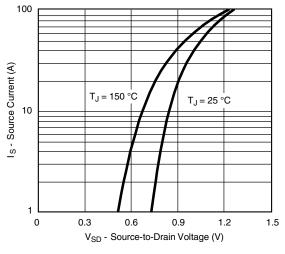
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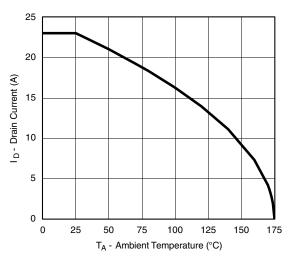
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



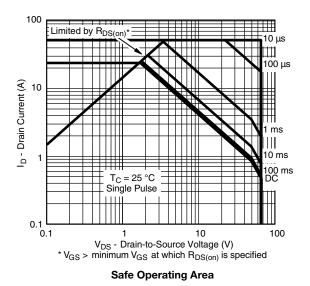
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



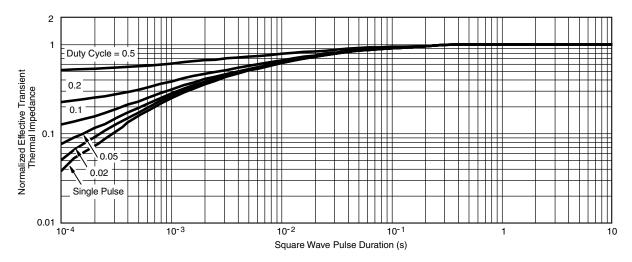
Maximum Drain Current vs. Ambient Temperature





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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72145.

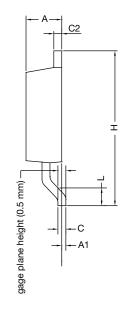


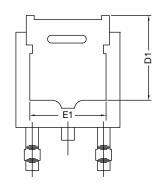


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	l ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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